

# **Final Product Change Notification**

202103030F01 : QN9080 HVQFN48 Assembly Site Expansion from ASEN to NXP-ATKH

**Note:** This notice is NXP Company Proprietary.

### Issue Date: Apr 01, 2021 Effective date: Jun 30, 2021

Dear Gordon Love,

Here is your personalized notification about a NXP general announcement. For detailed information we invite you to view this notification online

#### Change Category

[ ]Wafer Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[ ]Wafer Fab Materials	[]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
[ ]Wafer Fab Location	[X]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage
[]Firmware	[]Other			

## PCN Overview Description

NXP Semiconductors announces the Assembly site expansion for QN9080 HVQFN48 associated with this notification, from the current ASEN, Suzhou, China assembly facility to the NXP-ATKH, Kaohsiung, Taiwan assembly facility. Assembly site expansion was successfully qualified adhering to NXP specifications.

#### Reason

Qualification of the NXP-ATKH, Kaohsiung, Taiwan is required for manufacturing flexibility and customer supply assurance.

### Identification of Affected Products

Top Side Marking The assembly site is reflected in the package trace code. The format for the NXP standard trace code: xxYYWW[R][S] the second "x"=Assembly Location, The marking for ASEN is x=X. The marking for NXP-ATKH is x=S.

The pin1 identifier on exposed pad from both assembly sites are at same position, but shape is different. Details is in attached file.

### **Product Availability**

Sample Information

#### Samples are available upon request **Production** Planned first shipment Jul 19, 2021 **Anticipated Impact on Form, Fit, Function, Reliability or Quality**

No Impact on form, fit, function, reliability or quality **Data Sheet Revision** No impact to existing datasheet **Disposition of Old Products** NXP will reserve the right to ship from both locations based on market demand situation. **Additional information** 

Self qualification: <u>view online</u> Additional documents: <u>view online</u>

### **Timing and Logistics**

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by May 01, 2021.

### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Bin Lu

Position Product Engineer

e-mail address <u>bin.lu@nxp.com</u>

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NXP Quality Management Team.

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High Tech Campus, 5656 AG Eindhoven, The Netherlands

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